

SOT-223 Plastic-Encapsulate MOSFETS

Features

- $V_{DS}=60V$
- $I_D=5A$
- $R_{DS(on)}@V_{GS}=10V < 42m\Omega$
- $R_{DS(on)}@V_{GS}=4.5V < 50m$
- High power and current handing capability
- Voltage controlled small signal switch
- Fast Switching Speedze

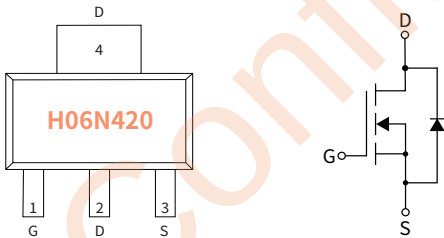
Applications

- Battery protection
- Load switch
- Power management

Mechanical Data

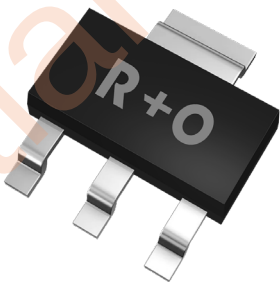
- Case: SOT-223
Molding compound meets UL 94V-0 flammability rating, RoHS-compliant,halogen-free
- Terminals: Solder plated, solderable per MIL-STD-750,Method 2026

Function Diagram



Drain-source Voltage
60 V
Drain Current
5 Ampere

SOT-223



Ordering Information

PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
SOT-223	R3	0.125	2500	5000	40000	13"

Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	VALUE
Drain-source Voltage	V_{DS}	V	60
Gate-source Voltage	V_{GS}	V	± 20
Drain Current	I_D	A	5
Pulsed Drain Current ⁽¹⁾	I_{DM}	A	24
Single Pulse Avalanche Energy ⁽²⁾	EAS	mJ	14.8
Total Power Dissipation	P_D	W	2
Junction temperature	T_J	°C	-55 ~+150
Storage temperature	T_{stg}	°C	-55 ~+150
Thermal Resistance Junction-to-Ambient @ Steady State	$R_{\theta JA}$	°C / W	62.5

● Static Parameter Characteristics (Tj=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	V	60	—	—
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V	μA	—	—	1.0
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V	nA	—	—	±100
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	V	1.2	1.6	2.5
Static Drain-Source On-Resistance ⁽³⁾	R _{DS(ON)}	V _{GS} =10V, I _D =5A	mΩ	—	32	42
		V _{GS} =4.5V, I _D =5A		—	42	50
Forward Transconductance	G _{FS}	V _{DS} =5V, I _D =5A	S	11	—	—

● Dynamic Parameters

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Input Capacitance	C _{iss}	V _{DS} =30V, V _{GS} =0V, f=1MHZ	pF	—	846	—
Output Capacitance	C _{oss}			—	65	—
Reverse Transfer Capacitance	C _{rss}			—	61.8	—

● Switching Parameters

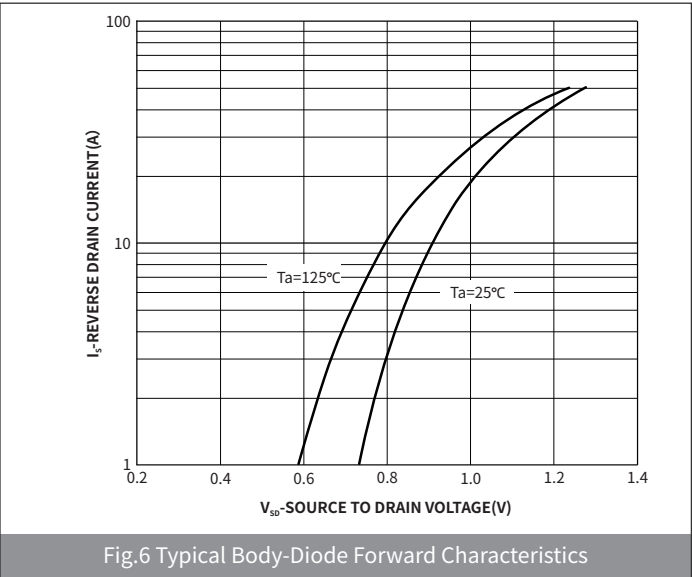
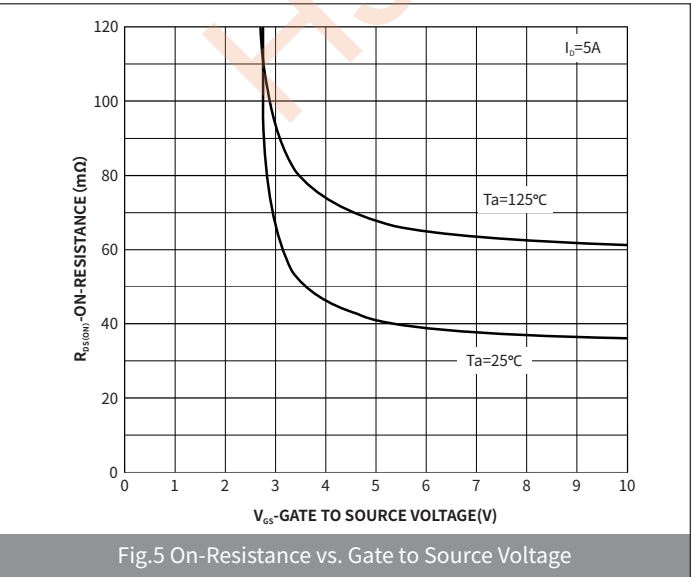
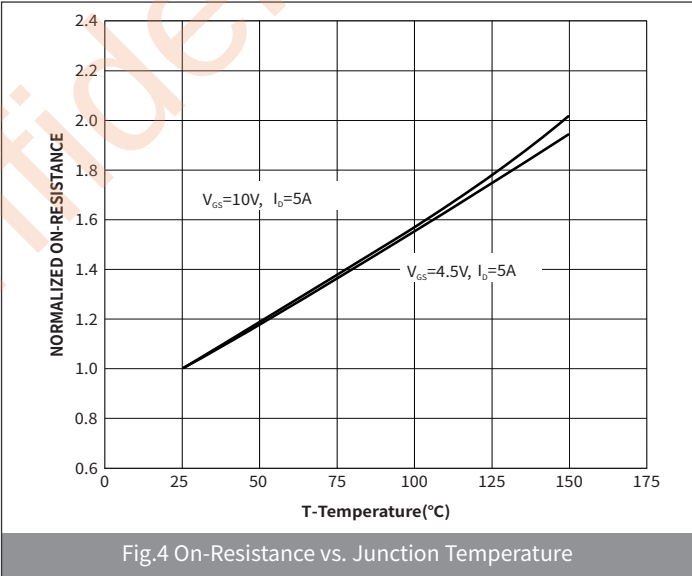
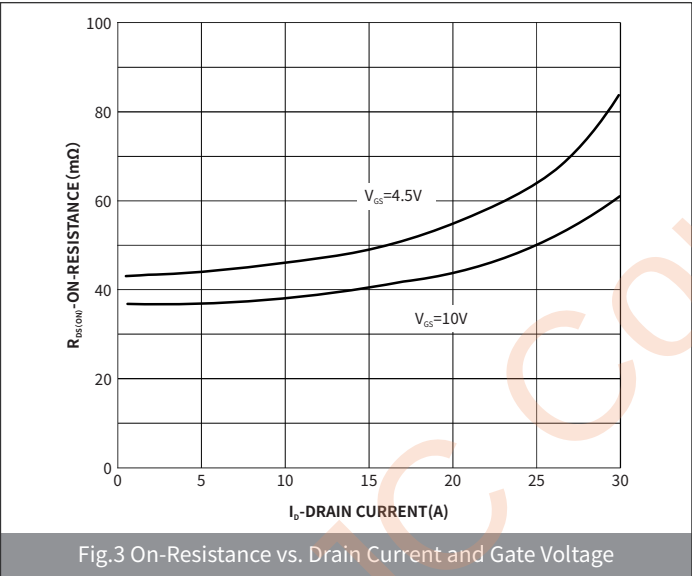
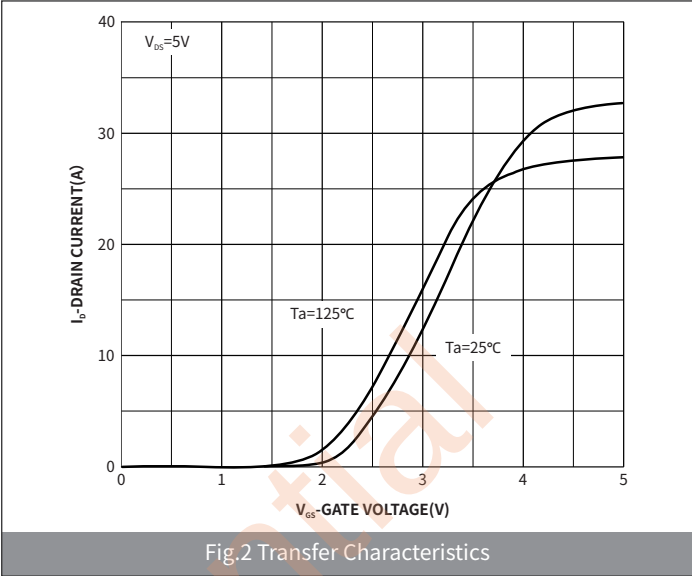
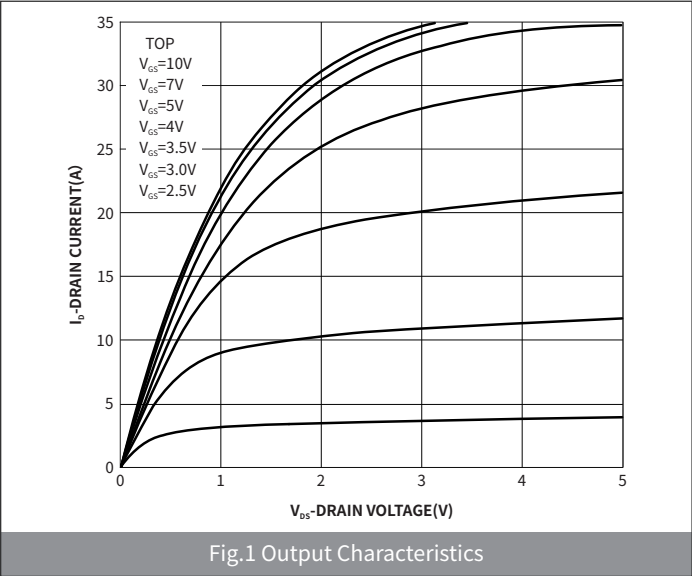
PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =30V, I _D =5A ,R _{GEN} =3Ω	nS	—	5.2	—
Turn-on Rise Time	t _r		nS	—	3	—
Turn-off Delay Time	t _{D(off)}		nS	—	17	—
Turn-off fall Time	t _f		nS	—	2.5	—
Total Gate Charge	Q _g	V _{DS} =30V, I _D =5A V _{GS} =10V	nC	—	25	—
Gate-Source Charge	Q _{gs}		nC	—	3	—
Gate-Drain Charge	Q _{gd}		nC	—	6.4	—

● Drian-Source Diode Characteristics

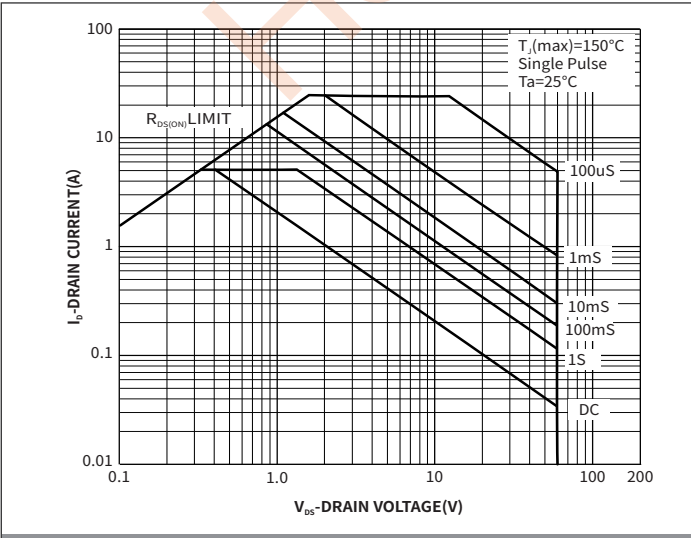
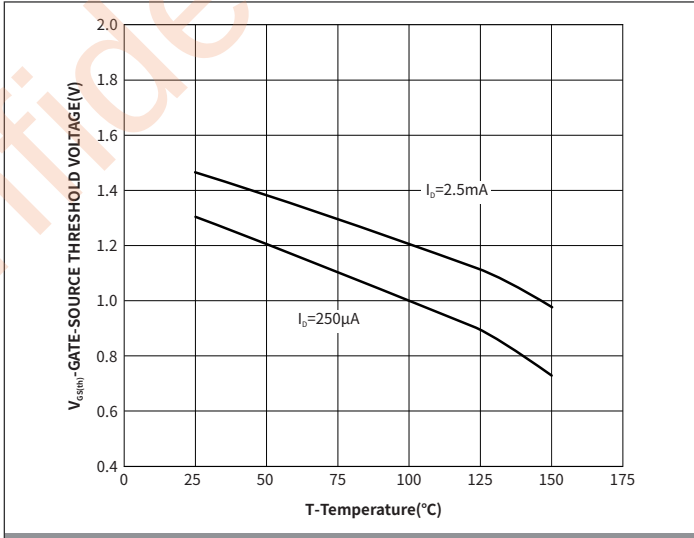
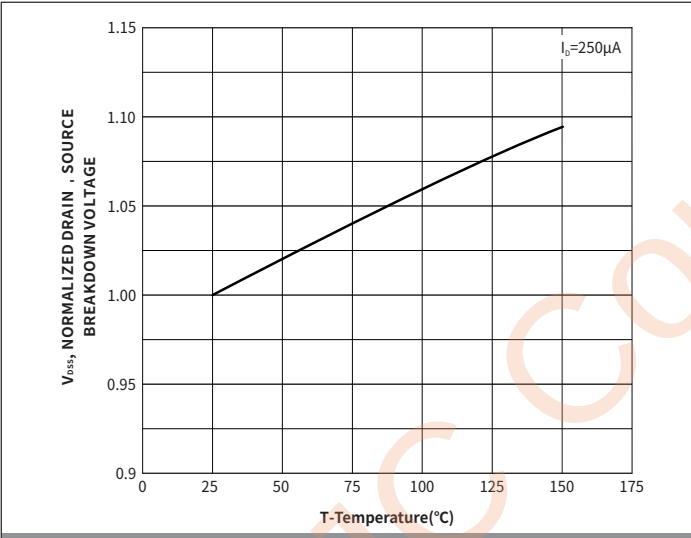
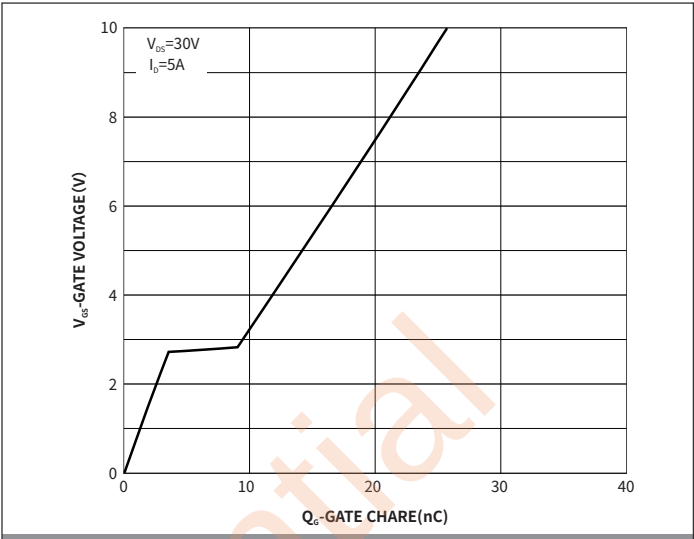
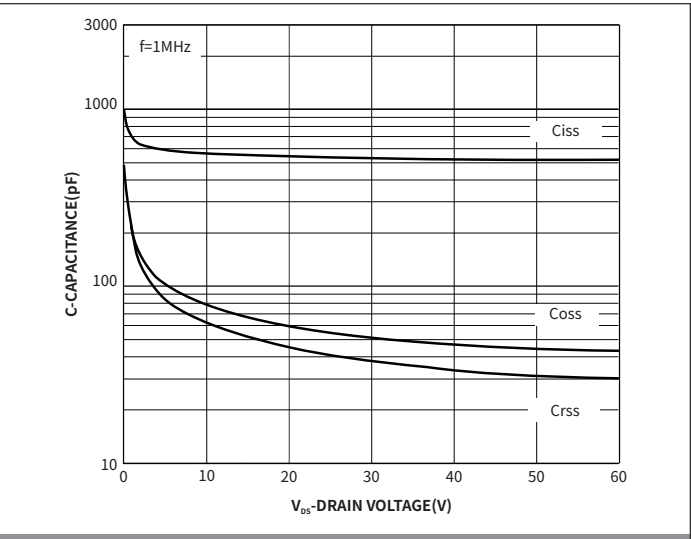
PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Diode Forward Voltage	V _{SD}	I _S =5A, V _{GS} =0V	V	—	—	1.2
Maximum Body-Diode Continuous Current	I _S	—	A	—	—	5

Note :
(1) Repetitive Rating: Pulse width limited by maximum junction temperature.
) EAS condition : Tj=25°C ,VDD=30V,VG=10V,L=0.5mH,IAS=7.7A.
(3) Pulse test: Pulse width ≤ 300us, duty cycle ≤ 2%.

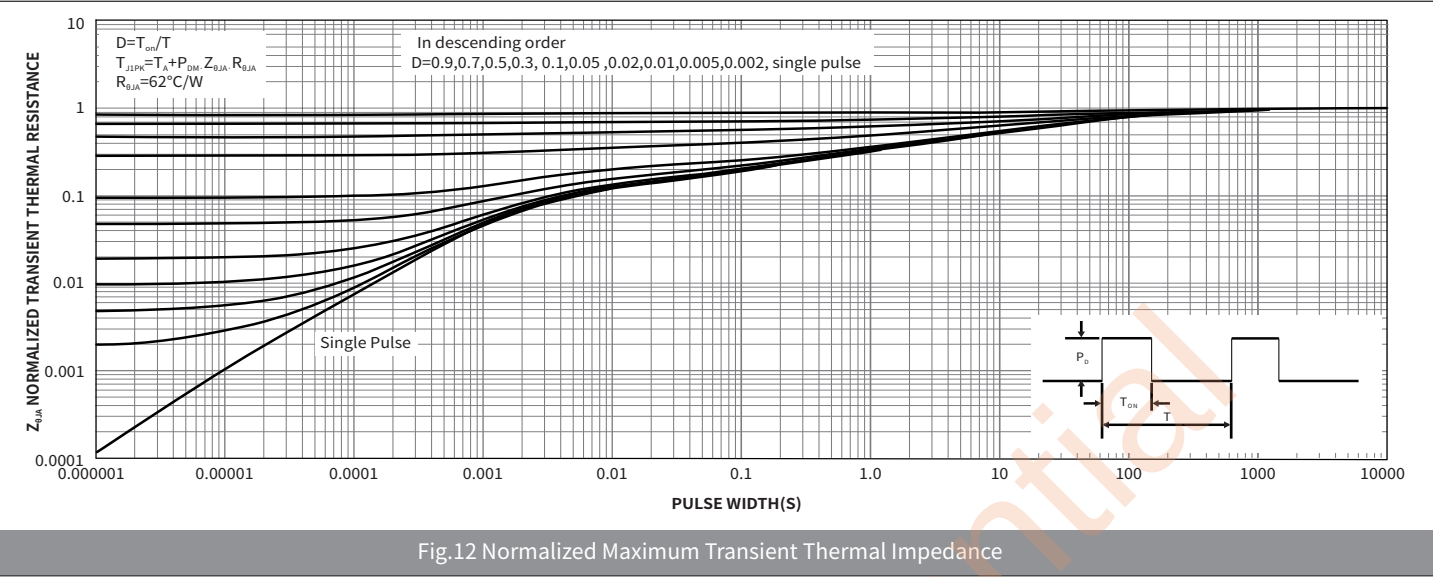
● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)



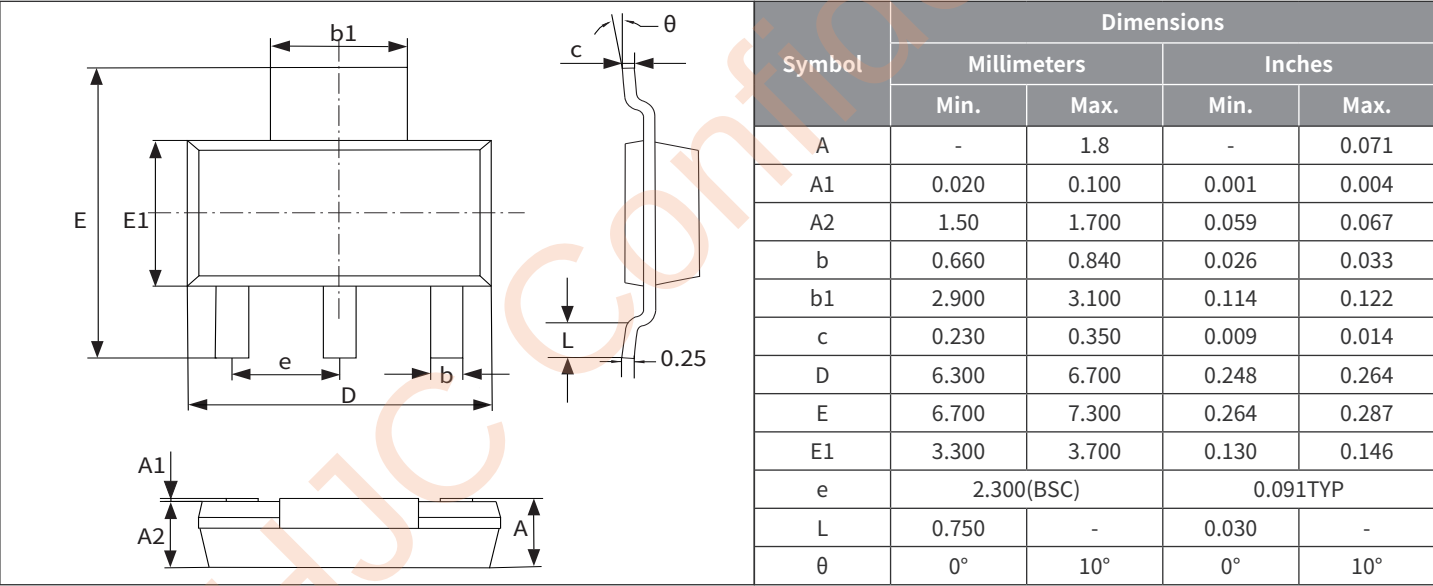
● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)



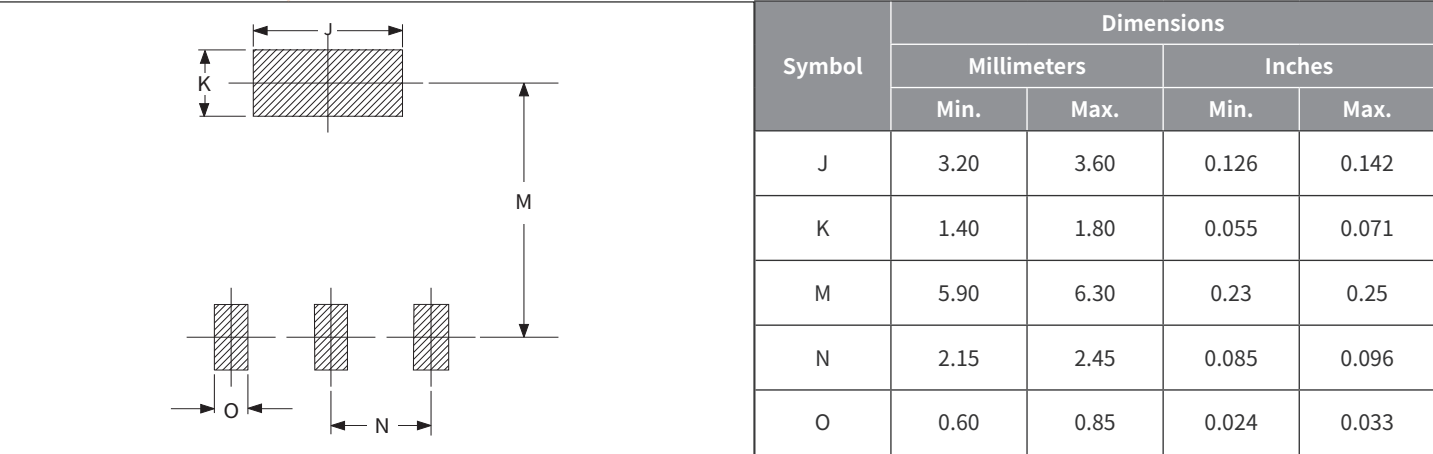
● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)



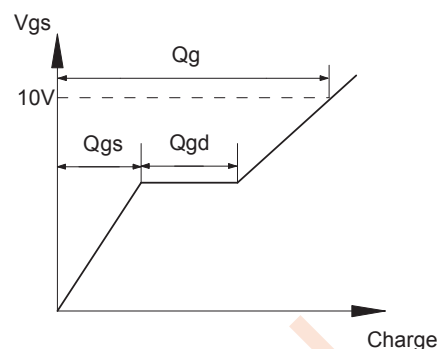
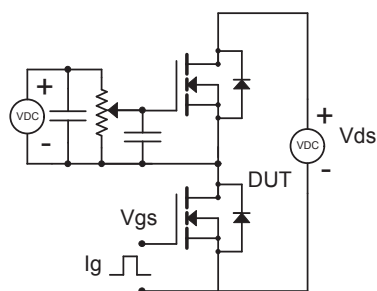
● Package Outline Dimensions (SOT-223)



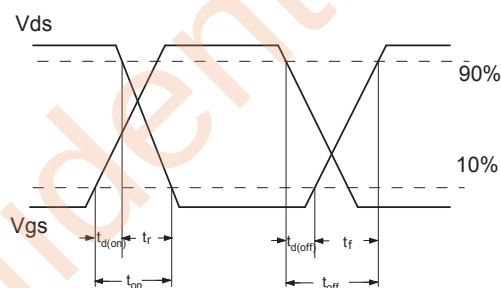
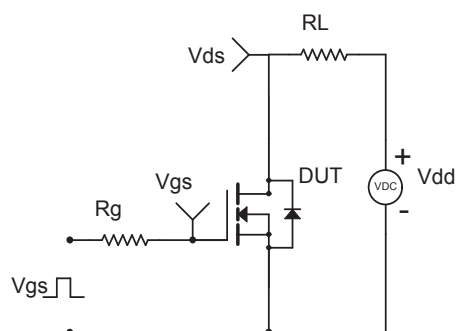
● Suggested Pad Layout



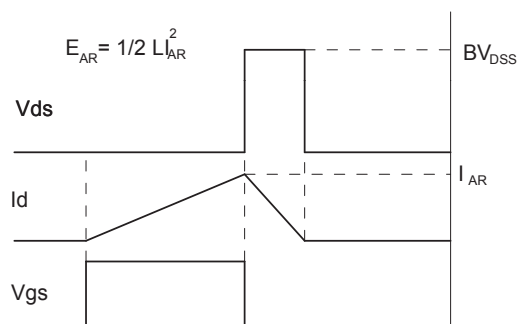
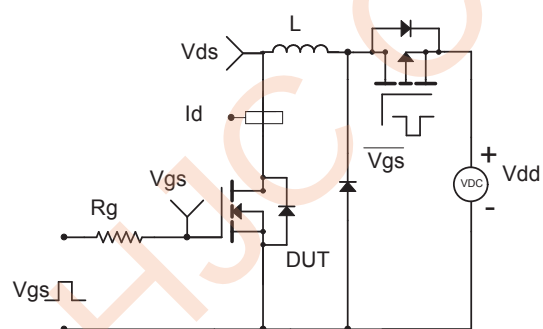
1. Gate Charge Test Circuit & Waveforms



2. Resistive Switching Test Circuit & Waveforms



3. Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



4. Diode Recovery Test Circuit & Waveforms

